

**AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A mask comprising:  
a mask body having a pattern opening; and  
a frame bonded to a first surface of said mask body,  
wherein a material evaporated from a deposition source is deposited on a substrate through said pattern opening of said mask body, said substrate being placed on said first surface of said mask body,  
wherein said material comprises an organic compound, and  
wherein said mask body is fixed to said frame in a stretched state and said mask body is adhesively bonded in a location coinciding with a line passing through a thermal expansion center in members of said frame.
2. (Previously Presented) The mask according to claim 1, wherein four corners of said frame have a curvature.
3. (Previously Presented) The mask according to claim 1, wherein said mask body is adhesively bonded to said frame with an adhesive material having heat resistance.
4. (Withdrawn) A thin-sheet mask comprising:  
a mask body having a pattern opening; and  
a frame,  
wherein said mask body is fixed to said frame in a stretched state and said mask body is adhesively bonded in a location on an outside of a line passing through a thermal expansion center in members of said frame,  
said frame is caused to expand by heating during deposition and said mask body maintains said stretched state.
5. (Withdrawn) The mask according to claim 4, wherein four corners of said frame have a curvature.

6. (Withdrawn) The mask according to claim 4, wherein said mask body is adhesively bonded to said frame with an adhesive material having heat resistance.

7. (Withdrawn) A container comprising:  
a part for accommodating a deposition material wherein said part for accommodating said deposition material is disposed in a deposition source of a deposition apparatus; and  
an opening provided on said part for accommodating said deposition material,  
wherein a cross section in a plane of said part for accommodating said deposition material has a rectangular or square shape and said opening through which said deposition material passes has a thin elongated shape.

8.-16. (Canceled)

17. (Currently Amended) A mask comprising:  
a mask body having an opening; and  
a mask frame bonded to a first surface of said mask body,  
wherein an EL material evaporated from a deposition source is deposited on a substrate through said opening of said mask body, said substrate being placed on said first surface of said mask body, and  
wherein said mask body is adhesively bonded to said mask frame in a location coinciding with a line passing through a thermal expansion center of said mask frame.

18. (Previously Presented) The mask according to claim 17, wherein four corners of said mask frame have a curvature.

19. (Previously Presented) The mask according to claim 17, wherein said mask body is adhesively bonded to said mask frame with an adhesive material having heat resistance.

20. (Currently Amended) A mask comprising:  
a mask body having an opening; and

a mask frame bonded to a first surface of said mask body,

wherein a material evaporated from a deposition source is deposited on a substrate through said opening of said mask body, said substrate being placed on said first surface of said mask body,

wherein said material comprises an organic compound, and

wherein said mask body is adhesively bonded to said mask frame in a location coinciding with a line passing through a thermal expansion center of said mask frame.

21. (Previously Presented) The mask according to claim 20, wherein four corners of said mask frame have a curvature.

22. (Previously Presented) The mask according to claim 20, wherein said mask body is adhesively bonded to said mask frame with an adhesive material having heat resistance.

23. (Withdrawn) A mask comprising:

a mask body having an opening; and

a mask frame,

wherein a material evaporated from a deposition source is deposited over a substrate through said opening of said mask body,

wherein said mask body is adhesively bonded to said mask frame in a location outside a line passing through a thermal expansion center of said mask frame to fix said mask body to said mask frame in a stretched state, and

wherein said mask frame is caused to expand by heating during the deposition of said material to maintain said stretched state.

24. (Withdrawn) The mask according to claim 23, wherein four corners of said mask frame have a curvature.

25. (Withdrawn) The mask according to claim 23, wherein said mask body is adhesively bonded to said mask frame with an adhesive material having heat resistance.

26. (Withdrawn) A mask comprising:  
a mask body having an opening; and  
a mask frame,  
wherein a material evaporated from a deposition source is deposited over a substrate through said opening of said mask body,  
wherein said material comprises an organic compound,  
wherein said mask body is adhesively bonded to said mask frame in a location outside a line passing through a thermal expansion center of said mask frame to fix said mask body to said mask frame in a stretched state, and  
wherein said mask frame is caused to expand by heating during the deposition of said material to maintain said stretched state.
27. (Withdrawn) The mask according to claim 26, wherein four corners of said mask frame have a curvature.
28. (Withdrawn) The mask according to claim 26, wherein said mask body is adhesively bonded to said mask frame with an adhesive material having heat resistance.
29. (Previously Presented) The mask according to claim 1, wherein said mask body is formed from a material having a same thermal expansion coefficient as said substrate.
30. (Previously Presented) The mask according to claim 17, wherein said mask body is formed from a material having a same thermal expansion coefficient as said substrate.
31. (Previously Presented) The mask according to claim 20, wherein said mask body is formed from a material having a same thermal expansion coefficient as said substrate.
32. (Currently Amended) The mask according to claim 1, wherein said frame is supported by an arm in said location coinciding with said line passing through said thermal expansion center in members of said frame.

33. (Previously Presented) The mask according to claim 17, wherein said mask frame is supported by an arm in said location coinciding with said line passing through said thermal expansion center of said mask frame.

34. (Previously Presented) The mask according to claim 20, wherein said mask frame is supported by an arm in said location coinciding with said line passing through said thermal expansion center of said mask frame.

35. (New) The mask according to claim 1, wherein a second surface, which is an opposite surface of said first surface, of said mask body is faced with said deposition source.

36. (New) The mask according to claim 17, wherein a second surface, which is an opposite surface of said first surface, of said mask body is faced with said deposition source.

37. (New) The mask according to claim 20, wherein a second surface, which is an opposite surface of said first surface, of said mask body is faced with said deposition source.

38. (New) The mask according to claim 1, wherein said substrate is in contact with said first surface of said mask body.

39. (New) The mask according to claim 17, wherein said substrate is in contact with said first surface of said mask body.

40. (New) The mask according to claim 20, wherein said substrate is in contact with said first surface of said mask body.